

08-10-00

A



UTILITY PATENT APPLICATION TRANSMITTAL (Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No.

13521(ARC9-2000-0067-US1)

Total Pages in this Submission

3

TO THE ASSISTANT COMMISSIONER FOR PATENTSBox Patent Application
Washington, D.C. 20231

Transmitted herewith for filing under 35 U.S.C. 111(a) and 37 C.F.R. 1.53(b) is a new utility patent application for an invention entitled:

CoFe ALLOY FILM AND PROCESS OF MAKING SAME

and invented by:

Emanuel Israel Cooper
Thomas Edward Dinan
Lubomyr Taras Romankiw
Hong Xu



If a CONTINUATION APPLICATION, check appropriate box and supply the requisite information:

Continuation Divisional Continuation-in-part (CIP) of prior application No.: _____

Which is a:

Continuation Divisional Continuation-in-part (CIP) of prior application No.: _____

Which is a:

Continuation Divisional Continuation-in-part (CIP) of prior application No.: _____

Enclosed are:

Application Elements1. Filing fee as calculated and transmitted as described below2. Specification having 33 pages and including the following:

- a. Descriptive Title of the Invention
- b. Cross References to Related Applications (*if applicable*)
- c. Statement Regarding Federally-sponsored Research/Development (*if applicable*)
- d. Reference to Microfiche Appendix (*if applicable*)
- e. Background of the Invention
- f. Brief Summary of the Invention
- g. Brief Description of the Drawings (*if drawings filed*)
- h. Detailed Description
- i. Claim(s) as Classified Below
- j. Abstract of the Disclosure

UTILITY PATENT APPLICATION TRANSMITTAL
(Large Entity)

(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No.
13521(ARC9-2000-0067-US1)

Total Pages in this Submission
3

Application Elements (Continued)

3. Drawing(s) (*when necessary as prescribed by 35 USC 113*)
a. Formal Number of Sheets _____ 6
b. Informal Number of Sheets _____

4. Oath or Declaration
a. Newly executed (*original or copy*) Unexecuted
b. Copy from a prior application (37 CFR 1.63(d)) (*for continuation/divisional application only*)
c. With Power of Attorney Without Power of Attorney
d. **DELETION OF INVENTOR(S)**
Signed statement attached deleting inventor(s) named in the prior application,
see 37 C.F.R. 1.63(d)(2) and 1.33(b).

5. Incorporation By Reference (*usable if Box 4b is checked*)
The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied
under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby
incorporated by reference therein.

6. Computer Program in Microfiche (*Appendix*)

7. Nucleotide and/or Amino Acid Sequence Submission (*if applicable, all must be included*)
a. Paper Copy
b. Computer Readable Copy (*identical to computer copy*)
c. Statement Verifying Identical Paper and Computer Readable Copy

Accompanying Application Parts

8. Assignment Papers (*cover sheet & document(s)*)

9. 37 CFR 3.73(B) Statement (*when there is an assignee*)

10. English Translation Document (*if applicable*)

11. Information Disclosure Statement/PTO-1449 Copies of IDS Citations

12. Preliminary Amendment

13. Acknowledgment postcard

14. Certificate of Mailing

First Class Express Mail (*Specify Label No.*): EL591790004US

UTILITY PATENT APPLICATION TRANSMITTAL
(Large Entity)

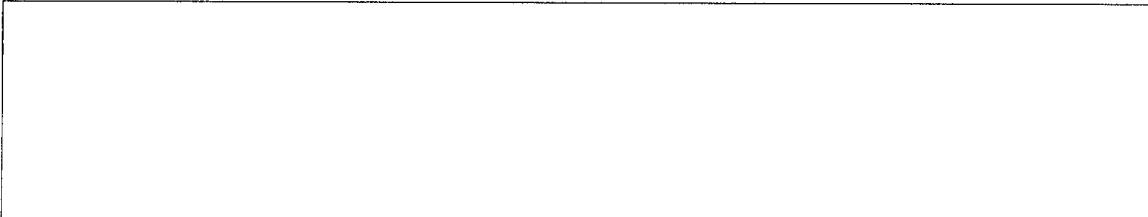
(Only for new nonprovisional applications under 37 CFR 1.53(b))

Docket No.
 13521(ARC9-2000-0067-US1)

Total Pages in this Submission
 3

Accompanying Application Parts (Continued)

15. Certified Copy of Priority Document(s) (*if foreign priority is claimed*)

16. Additional Enclosures (*please identify below*):


Fee Calculation and Transmittal

CLAIMS AS FILED

For	#Filed	#Allowed	#Extra	Rate	Fee
Total Claims	27	- 20 =	7	x \$18.00	\$126.00
Indep. Claims	2	- 3 =	0	x \$78.00	\$0.00
Multiple Dependent Claims (check if applicable)	<input type="checkbox"/>				\$0.00
				BASIC FEE	\$690.00
OTHER FEE (specify purpose)					\$0.00
				TOTAL FILING FEE	\$816.00

A check in the amount of _____ to cover the filing fee is enclosed.

The Commissioner is hereby authorized to charge and credit Deposit Account No. 09-0441 as described below. A duplicate copy of this sheet is enclosed.

Charge the amount of \$816.00 as filing fee.

Credit any overpayment.

Charge any additional filing fees required under 37 C.F.R. 1.16 and 1.17.

Charge the issue fee set in 37 C.F.R. 1.18 at the mailing of the Notice of Allowance, pursuant to 37 C.F.R. 1.311(b).



Marvin Bressler

Registration No. 25,132

SCULLY, SCOTT, MURPHY & PRESSER

400 Garden City Plaza

Garden City, New York 11530

516-742-4343

Dated: August 9, 2000

CC:

CoFe ALLOY FILM AND PROCESS OF MAKING SAME

BACKGROUND OF THE DISCLOSURE

5

1. Field of the Invention

The present invention is directed to a CoFe soft magnetic thin film alloy having magnetic properties well suited for use in the fabrication of thin film 10 magnetic recording heads and a process for making same. More specifically, the present invention is directed to a CoFe alloy thin film in which the iron constituent is present in a concentration of between about 55 wt.% and 15 75 wt.% iron and a process for making same.

15

20

The application of this high saturation magnetization CoFe thin film also includes magnetic shields for magnetoresistive read heads, magnetic actuators which may require high moment low Hc materials, application in Micro-Electro Mechanical Systems (MEMS), soft magnetic underlay in magnetic perpendicular recording disk and other applications in electronics. All the above areas require thin electroplated magnetic films because cast materials cannot be used.

25

2. Background of the Prior Art

30

The ever expanding demand for greater storage density in magnetic recording systems has correspondingly led to increased demand for magnetic storage media with increased coercivity and higher a real storage density. In order to write to these higher coercivity media it is necessary to have write heads which will put out a higher

magnetic flux. Write heads which put out a higher magnetic flux must be made of magnetic pole materials with a higher saturation magnetization.

5 At present, the highest moment alloy films commercially available are nickel-iron alloys having a saturation magnetization of about 1.75 Tesla. Higher moment alloys are known in the art. These higher moment alloy films are electrodeposited films of an alloy of
10 cobalt-nickel-iron and cobalt-iron-copper having a saturation magnetic moment of 1.9 to 2.0 Tesla.

15 In spite of these advances in the development of write head materials, there is a continuing need for the development of magnetic thin films having even higher magnetic moment values.

20 Although cobalt-iron (CoFe) alloys in the 55-75 wt.% Fe range are known to provide high saturation magnetization, such alloys have been formulated by casting. Obviously, the formation of a very thin film, suitable for use in write head applications, from a cast alloy is not obtainable. The fabrication of such a film by sputtering, vapor deposition and electroplating have
25 been attempted. Sputtering does not produce a film having anisotropic characteristics, which is essential in write head applications. Vapor deposition results in course grained films which are also unsuitable in this application. Electrodeposition, however, represents a
30 most promising method to form improved thin film CoFe alloy thin films for application as write heads.

Past attempts to produce high-iron CoFe alloy electrodeposited films have failed to generate films having satisfactory magnetic and mechanical properties. Typical electrodeposited CoFe films have high magnetic
5 coercivity, poor or non-existent magnetic anisotropy, saturation magnetization ($4\pi M_s$) substantially lower than the theoretical 2.40-2.45 Tesla, and are so stressed that they cannot be plated to a useful thickness (which in
10 write heads is in the 1-3 micron range) without delamination. This poor performance can be ascribed at least in part to the incorporation of oxygen into the electroplated CoFe film during deposition, a characteristic which does not occur when a CoFe alloy is cast. Thus, new thin film CoFe alloys and new processes
15 for making such films which are substantially free of oxygen represents a well established need in the art.

CoFe-containing alloys, including films of such alloys, as well as processes for their manufacture, are known in the art. Examples of the most pertinent of such art are included hereinbelow.

U.S. Patent 4,756,816 describes a process for the electrodeposition of a cobalt-iron alloy on a substrate. This process occurs in an aqueous electrolytic plating bath. The cobalt-iron alloy has an approximate cobalt to iron weight ratio of 90:10. The plating solution also has sodium saccharin, dodecyl sodium sulfate and wetting and buffering agents. The CoFe thin film that results from using the disclosed process has near zero magnetostriction, acceptable permeability for use as a magnetic head, a highly
25
30

stabilized magnetic domain and approximately 2.0 Tesla saturation magnetization. Magnetic heads fabricated from such films are well suited for use with high coercivity media for high density magnetic recording.

5

U.S. Patent 5,372,698 is directed to a process of forming a thin film magnetic read/write head having a thin film magnetic core and a substrate upon which a crystalline magnetic alloy of cobalt, iron and boron is electrodeposited. The cobalt-iron-boron core is 90% cobalt and has a saturation magnetization of 1.9 Tesla.

10

Japanese Patent Publication 6036929 sets forth a wet plating method for making a magnetic thin film. The method involves plating a cobalt-iron-tin alloy in which the tin constituent is present in a concentration of 8 to 25 wt.%.

15

Japanese Patent Publication 4-229607 discloses a magnetic thin film formed in an electroplating method in which the coating alloy is mainly cobalt but also includes iron in a concentration of 2 to 15 wt.% and sulfur in a concentration of 500 to 2,000 ppm. The sulfur constituent is provided by a sulfinic acid group or its salt, a sulfonic acid group or its salt, a sulfonimide group, a sulfonamide or a thiourea-based compound and mercaptodicarboxylic acid. However, the alloy composition disclosed in this Japanese patent refers to a high cobalt content alloy (85 wt.% to 98 wt%) and does not cover alloys containing lower Co concentration. In addition, although we have no indication of the value of the saturation magnetization,

20

25

30

we can estimate its value being below 2.5 Tesla based on the general trend among high cobalt-content CoFe alloys.

5 Japanese Patent Publication 2-107,737 teaches an amorphous soft magnetic film which includes cobalt, iron, tin and phosphorus.

10 U.S. Patent 2,654,703 describes the electrodeposition of bright nickel, cobalt, and alloys thereof from acid baths, using aryl (aromatic) sulfinic acids or salts thereof. The plating of cobalt-iron alloys is not claimed; in fact, sulfinites are said to retard the rate of codeposition of iron if ferrous salts are added to such baths, which, if true, would obviously 15 be undesirable in the plating of high-iron cobalt alloys. No mention is made of any magnetic properties or uses of these alloys.

20 U.S. Patent 5,587,026 concerns a ferromagnetic film which has high saturation magnetic flux density. The film is an alloy of cobalt, iron and a metal selected from the group consisting of tantalum, titanium, zirconium, hafnium, molybdenum and tungsten. The addition of a ternary element to the CoFe alloy system 25 can achieve relatively high saturation magnetic flux density ($4\pi M_s$) between ~1.5 to 1.9 Tesla and after high temperature annealing a coercivity lower than 1.88 Oersteds. The cobalt content of the ferromagnetic film is 73 at% to 94 at%.

30

U.S. Patent 4,306,908 is directed to a ferromagnetic amorphous alloy having the formula

(Co_xNi_yFe_z)_aM_bG_c, where M is Cr, Mo and/or W; G is Zr, Hf and/or Ti; x=1-y-z; 0≤y≤0.2; 0≤z≤0.7; a=1-b-c; 0≤b≤0.5; and 0.05≤c≤0.2.

U.S. Patent 4,933,026 involves a soft magnetic cobalt-iron alloy which includes 0.15% to 0.5% Ta, Nb or mixtures thereof. The cobalt constituent of the alloy is present in a concentration of between about 33% and 55%. This alloy is stated to be operable at temperatures as high as between 960° and 980°C, up to 100°C above the highest possible operable temperature of earlier approximately equal weight cobalt-iron alloys. The cast alloy of this disclosure is fabricated by vacuum melting and hot rolling a cast ingot to 2.5 mm thickness, reheating the strip to above the order-disorder temperature, i.e. about 800°C, and quenching in a brine solution below 0°C. However, the use of the very high temperatures (above 1500C) required in the production of CoFe cast alloy is not compatible with the fabrication of magnetic recording thin film heads which makes this CoFe alloy unusable for such an application. More generally, the casting process of this patent is not suitable for the preparation of thin film structures.

U.S. Patent 4,925,502 provides a soft cobalt-iron alloy which consists essentially of 35% to 60% by weight Co; 0.03% to 2% by weight Al and the remainder iron. This alloy is formed by compacting and sintering cobalt, iron and aluminum or iron-aluminum powders. The sintering process used in the '502 patent implies the application of very high temperatures (~1400C) and is consequently not compatible with the fabrication of magnetic recording thin film heads and the like.

An article by L.H. Chen et al. entitled "Soft-Magnetic Properties of Fe-Co-B Thin Films for Ultra-High-Frequency Applications" in J. Appl. Physics, Vol. 87, Number 9, pp 5858-5860 (May 2000) describes an amorphous CoFeB thin film sputter deposited at a composition of 67 at% iron, 18 at% cobalt and 15 at% boron. Although this thin film exhibits a very low coercivity of about 0.3 Oersted, the saturation magnetization is very low ($4\pi M_s \sim 1.75$ Tesla). Moreover, by conventional RF magnetron sputtering technique, a perpendicular magnetic anisotropy tends to occur easily, which would be strongly detrimental to the performance of magnetic recording thin film heads.

An article by S.S. Abd El Rehim et al., "Electroplating of CoFe Alloys from Aqueous Acetate Bath" in Trans. IMF, 2000, 78 (1), pp 41-42 shows CoFe thin films with a composition ranging from about 43 % up to about 66 % iron (no indication if they are weight or atomic percentages). The alloy composition disclosed in this article has microcracks and is consequently not suitable for the fabrication of magnetic recording thin film heads and the like. Moreover, the authors do not give any indication concerning the magnetic properties of these CoFe alloys.

The full range of CoFe compositions has been investigated by E.M. Kakuno et al. in "Structure, Composition, and Morphology of Electrodeposited $\text{Co}_x\text{Fe}_{1-x}$ Alloys" in J. Electrochem. Soc., Vol. 144, No. 9, September 1997, pp. 3222-3226 from an additive-free sulfate-based plating bath. The $\text{Co}_x\text{Fe}_{1-x}$ thin films with

an alloy composition varying from $x=1$ to 0 show heterogeneous morphology and composition and are then not suitable for the fabrication of magnetic recording thin film heads and the like. No indication of the magnetic properties of these alloys is given in this article.

In U.S. Patent 4,208,254, the patentees disclose a method of electrodepositing a CoFe alloy having a composition of 7.5-55 wt.% iron, the remaining being cobalt, from a fluoride-containing bath. No saturation magnetization value is given in this patent disclosure.

Soft magnetic amorphous CoFeP alloys have been reported in the literature. For example, J. Herretos et al., "Preparation of Fe-Co-P Amorphous Alloys by Electrodeposition" in J. of Non-Crystalline Solids, 201 (1996) pp. 102-109 have electrodeposited a $\text{Fe}_{56}\text{Co}_{30}\text{P}_{14}$ alloy with a coercivity of about 2 to 5 Oersteds. There is no indication of saturation magnetization. Although amorphous CoFeP alloys have been shown to exhibit excellent soft magnetic properties, they generally have a lower saturation magnetization due to the addition of glass forming agent in relatively high concentrations.

Another type of amorphous CoFe alloy is obtained by the addition of boron as described in U.S. Patent 5,372,698 where the patentees disclose an electrodeposited CoFeB with an iron content between about 7 wt.% and about 12 wt.%, a boron content between about 0.1 wt.% and about 2.0 wt.%, the remaining being cobalt and having a saturation magnetization ($4\pi M_s$) of about 1.9

Tesla and a coercivity of about 1.0 Oersted. Despite good soft magnetic properties, the cobalt content (about 90 wt.%) of this alloy is between 25 wt.% and 45 wt.%. Moreover, the alloy of this patent has a low magnetization.

5

An electrodeposited CoFe alloy containing vanadium is presented by Arcos et al., "Direct and Pulse Current Electrodeposition of Ternary CoFeX, CoNiX and NiFeX Thin Film Alloys" in Proc. of the 4th Int. Symp. on Mag. Mat. Proc. and Dev., L.T. Romankiw and D.A. Herman, Jr. Eds, 95-18, (1995), pp. 563-569. CoFeV electrodeposites having a magnetic moment of about 2.0 Tesla are presented in this study. However, no clear indication of the alloy composition and no indication of the coercivity is provided. Furthermore, the saturation magnetization of about 2 Tesla is too low for this material to be used in the fabrication of advanced magnetic recording thin film heads.

10

The addition of copper to the electrodeposited CoFe alloy is disclosed by Andricacos et al. in U.S. Patent 5,582,927 where a $\text{Co}_x\text{Fe}_y\text{Cu}_z$ alloy with a composition in the range of about 65 wt.% to 92 wt.% cobalt, about 6 wt.% to 15 wt% iron and about 2 wt% to 20 wt.% Cu has been electrodeposited. This alloy has a high saturation magnetization ($4\pi M_s$) in the range of 1.6 Tesla to 2.4 Tesla and a coercivity of less than 1 Oersted. However, these excellent soft magnetic properties require a very low iron content CoFe alloy, i.e., less than 15 wt%.

15

20

25

30

In U.S. Patents 4,014,759 and 4,053,373 an α -hydroxy sulfone compound, which is the reaction product of an aromatic sulfinate and an aldehyde or dialdehyde, is used in iron-containing baths to improve plating of 15 wt.% to 70 wt.% Fe-containing alloys of nickel or cobalt or nickel and cobalt.

Finally, Liu, et al., Journal of Applied Physics, Vol. 87, no. 9, 5410-5412 (2000) describes the electrodeposition of cobalt-iron-nickel alloy thin films for magnetic recording heads. This deposition occurs in the absence of sulfur-containing additives. Although the coercivity of these films was about 1 Oe, the saturation magnetization was only 2.0 Tesla.

15

SUMMARY OF THE INVENTION

A new alloy film and process for making that soft magnetic thin film alloy has now been developed which provides a saturation magnetization ($4\pi M_s$) above the maximum saturation magnetization ($4\pi M_s$) obtained by commercially available soft magnetic thin film alloys. The newly developed soft magnetic thin film is particularly suitable for use as a write head in magnetic recording.

The soft magnetic thin film alloy of the present invention is a CoFe alloy fabricated in an electroplating process from an aqueous plating bath to produce a smooth, bright surfaced film indicative of the substantial absence of oxygen and iron oxide. A paddle cell with continuous filtration is used for the

electroplating process. A magnetic field of 700-800
Gauss can be used during plating to magnetically orient
the electroplated CoFe alloy film. The resulting soft
magnetic thin film alloy has relatively low stress and
can be plated to thickness up to 2 microns.

In accordance with the present invention a cobalt-iron film comprising between about 55% and about 75% iron and the remainder cobalt, said percentages being by weight based on the total weight of the alloy, is provided. The film is further characterized by a maximum saturation magnetization ($4\pi M_s$) of at least about 2.30 Tesla.

In further accordance with the present invention a process of making the cobalt-iron alloy film is disclosed. In that process the cobalt-iron alloy film is electrodeposited from an aqueous medium which includes one or more ferrous salts; one or more cobaltous salts; a buffer having a pKa of about 6 to about 8 which does not co-deposit into the plated CoFe thin film alloy; one or more mono- or polycarboxylic acids having pKa(s) in the range of between about 3.5 and about 5.5; an aromatic sulfinic acid or a salt thereof; optionally, a chloride salt; and optionally, a surfactant.

BRIEF DESCRIPTION OF THE DRAWINGS

The present invention may be better understood by reference to the drawings of which:

Figure 1 is a graph of easy axis coercivity (H_c) as a function of weight percent iron of a CoFe soft magnetic thin film alloy;

5 Figure 2 is a graph of saturation magnetization ($4\pi M_s$) as a function of weight percent iron of a CoFe soft magnetic thin film alloy;

10 Figure 3 is a graph of film resistivity (in $\mu\Omega\text{-cm}$) as a function of weight percent iron of a CoFe soft magnetic film alloy;

15 Figure 4 is a graph of film stress as a function of weight percent iron of a CoFe soft magnetic thin film alloy;

20 Figure 5 is a graph of hard axis coercivity (H_c) as a function of weight percent iron of a CoFe soft magnetic thin film alloy; and

25 Figure 6 is a graph of magnetic anisotropy (H_k) as a function of weight percent iron of a CoFe soft magnetic thin film alloy.

25 DETAILED DESCRIPTION

The cobalt-iron (CoFe) alloy film of the present invention, characterized by a bright, smooth finish, is substantially free of oxygen and iron oxide. The CoFe film is preferably a thin film having a thickness up to 2 microns.

The CoFe soft magnetic thin film alloy comprises about 55% and about 75% iron and the remainder, between about 25% and about 45%, cobalt, the percentages being by weight, based on the total weight of the alloy film. Preferably, the constituency of the CoFe alloy film is about 60% to about 66% iron and the remainder, between about 34% and about 40%, cobalt. More preferably, the CoFe alloy film is present in a concentration of between about 62% and about 65% iron and the remainder, between about 35% and about 38%, cobalt.

The CoFe alloy film is further defined by a maximum saturation magnetization, also denoted by the scientific notation, $4\pi M_s$, of between about 2.3 and about 2.5 Telsa. Preferably, the $4\pi M_s$ of the CoFe alloy film is in the range of between about 2.32 and about 2.50 Tesla. More preferably, the maximum saturation magnetization of the CoFe alloy is in the range of between about 2.38 and about 2.53 Telsa.

The CoFe alloy film is anisotropic, as defined by an easy axis coercivity (H_{ce}) of no more than 22 Oersted (Oe), which drops to no more than about 12 Oe upon annealing; a hard axis coercivity (H_e) of no more than about 17 Oe, which drops to no more than about 9 Oe upon annealing; and a magnetic anistropy (H_k) of no more than about 30 Oe, which is substantially unchanged upon annealing.

Preferably, the anisotropic properties of the CoFe alloy film are manifested by an easy axis coercivity of no more than about 17 Oe, which drops to no more than

about 8 Oe upon annealing; a hard axis coercivity of no more than about 7 Oe, which drops to about 3.5 Oe upon annealing; and a magnetic anisotropy of no more than about 24 Oe which is substantially unchanged upon annealing.

5

More preferably, the CoFe alloy film has the following anisotropic properties: an easy axis coercivity of no more than about 15 Oe, which drops to no more than about 6 Oe upon annealing; a hard axis coercivity of no more than about 5 Oe, which drops to no more than about 2.5 Oe upon annealing; and a magnetic anisotropy of no more than about 20.5 Oe, which is substantially unchanged upon annealing.

10

15

The CoFe alloy film is further characterized by a specific resistivity in the range of between about 17 and about 65 $\mu\Omega\text{-cm}$. Preferably, the CoFe alloy film has a specific resistivity of between about 24 and about 42 $\mu\Omega\text{-cm}$. Most preferably, the specific resistivity is in the range of between about 30 and about 40 $\mu\Omega\text{-cm}$.

20

The CoFe alloy film is characterized by an internal mechanical tensile stress of between about 250 and about 800 MegaPascals (MPa). Preferably, the film is characterized by a stress of between about 470 and about 700 MPa. More preferably, the CoFe alloy film is characterized by a stress of between 600 and about 630 MPa.

25

30

The CoFe alloy film of the present invention is prepared by a process in which the film is electroplated

from an aqueous chemical plating bath. The plating bath is characterized by a pH of about 2.5 to about 3.5. The minimum pH is limited by hydrogen evolution and reduced current efficiency, and the maximum pH by the propensity of ferrous ions to oxidize and precipitate as ferric compounds. Preferably, the pH is in the range of between about 2.8 and about 3.2.

The plating bath is an aqueous solution of one or more ferrous salts, of which the anion is preferably sulfate; one or more cobaltous salts of which the anion is preferably sulfate; a buffer having a pKa of about 6 to about 8 which does not co-deposit into the plated CoFe thin film alloy, e.g. boric acid; one or more mono- or polycarboxylic acids having pKa(s) in the range of between about 3.5 and about 5.5, e.g. acetic acid; an aromatic sulfinic acid or a salt thereof; optionally, a halide salt; and, optionally, a surfactant. Preferably, the pH of the plating bath is between about 2.8 and about 3.2. The plating solution is preferably recirculated continuously through a fine filter (0.2-0.5 micron) in order to avoid precipitation of ferric compounds.

The electroplating operation is conducted at an average cathodic current density of between about 3 milliamperes/square centimeters (mA/cm^2) and about 40 mA/cm^2 . Preferably, the average cathodic current density is in the range of between about 5 mA/cm^2 and about 30 mA/cm^2 . More preferably, the plating operation is conducted at an average cathodic current density of between about 10 mA/cm^2 and about 20 mA/cm^2 . Various current versus time programs may be used in the plating,

including, but not limited to, direct current, pulsed current, cathodic based sinusoidal current and pulsed reversed current. The electroplating may also be accomplished on various thin film electrically conductive substrates which have been properly prepared for plating (in a manner known by those skilled in the art). These substrates may include, but are not limited to, nickel-iron alloys, nickel-cobalt alloys, iron-cobalt alloys, cobalt-nickel-iron alloys, iron-nitrogen alloys, iron-aluminum-nitrogen alloys, rhodium, ruthenium, platinum, gold, copper and palladium. An iron or a cobalt anode can be used in the plating equipment. Dimensionally stable anodes of platinized titanium, platinum, graphite or carbon can also be used. A cobalt anode is preferred as it undergoes anodic dissolution easily and does not cause substantial oxidation of the ferrous ion in solution.

Turning to the specific constituents of the plating bath, the mono or polycarboxylic acid is preferably acetic acid. Other monocarboxylic or polycarboxylic acids which may also be used include succinic acid, glutaric acid and methylsuccinic acid. Sugar alcohols, such as mannitol or sorbitol, may also be used as part of the buffer mixture.

The mono or polycarboxylic acid is provided in a concentration in the range of between about 0.01 Molarity (M) and 0.4M. Preferably, the carboxylic acid is present in a concentration of between about 0.02 M and about 0.33 M. More preferably, the carboxylic acid concentration ranges between about 0.02 M and 0.25 M.

The buffer, as suggested above, is preferably boric acid, which has been shown to have a pKa of 6 to 8 in the electroplating bath described here. Other buffers, which may also be used instead of boric acid,
5 include alkyl-substituted pyridines such as picolines and lutidines. In particular, such picolines and lutidines as 2-picoline and 2,6-lutidine are preferred. As stated above, buffers other than those recited above, which have a pKa of 6 to 8 and do not co-deposit into the plated
10 CoFe thin film alloy, can be employed.

This buffer is present in an amount in the range of between about 0.08 Molarity (M) and about 0.65 M; preferably, between about 0.16 M and about 0.49 M; and
15 more preferably, between about 0.32 M and about 0.44 M.

The halide salt employed in the plating bath is preferably a chloride or a bromide salt in which the cation is an alkali metal, an alkaline earth metal,
20 cobalt or iron. Other inorganic halides may be used provided that the cation produced during solvation does not plate into the thin film CoFe alloy. In addition, organic halides may be used provided they do not adversely affect the plating rate or plated film quality.
25 Of these, alkali metal halides are preferred. Of the alkali metal halides, sodium chloride is most preferred.

The halide salt constituent of the plating bath is present in a concentration of about 0.0017 Molarity (M) to about 0.0342 M; preferably, between about 0.0051 M and about 0.0171 M; and more preferably, between about 0.0068 M and about 0.0120 M.
30

The inorganic cobalt salt of the plating bath is any soluble salt of cobalt. Among preferred soluble cobalt salts are hydrates. As indicated above, it is preferred that the cobalt salt be a sulfate although a chloride or a bromide salt is acceptable.

5

The ferrous salt of the plating bath, like the cobalt salt, is any soluble ferrous salt. Also, like the cobalt salt, a preferred class of soluble ferrous salts are hydrates. Indeed, in accord with the cobalt salts, sulfates are particularly preferred although a chloride or a bromide may be employed.

10

As those skilled in the art are aware, the concentration of the cobalt salt in the electroplating bath, relative to the concentration of the iron salt, dictates the concentration of the electroplated CoFe alloy film. Thus, this concentration varies depending upon the desired constituency of the CoFe film. Preferably, though, the range of iron metal ion (2+ valence) in the bath is in the range of about 0.10 Molarity (M) to about 1.50 M.

15

The aromatic sulfinic compound of the electroplating bath is preferably an aromatic sulfinic acid or a salt thereof. The aromatic sulfinic salt form is preferable because aromatic sulfinic salts tend to be more soluble than aromatic sulfinic acids. The cation of the salt can be any metal ion that is inert under plating conditions, e.g. sodium or potassium. The acid can be any sulfinic derivative of benzene or naphthalene, with optional additional substituents (on the aromatic ring)

20

25

30

that are inert under the plating conditions. Thus, such substituents as alkyl, chloro, and alkoxy may be present.

A preferred aromatic sulfinic compound is
5 benzenesulfinic acid. More preferably, a sodium salt of
a benzenesulfinic hydrate salt, the sodium dihydrate salt
of benzenesulfinic acid, sodium benzenesulfinate
dihydrate, is employed. Other aromatic sulfinic acids or
salts that can be employed include sodium
10 toluenesulfinate, sodium p-chlorobenzenesulfinate and the
like.

The benzenesulfinate salt is present in the
plating bath in a concentration of about 0.000061
15 Molarity (M) to about 0.001218 M; preferably, between
about 0.000091 M to about 0.000914 M; and more
preferably, between about 0.000122 M to about 0.000610 M.
The sulfinate additive is slowly consumed both by plating
and by air oxidation; therefore, periodic replenishment
20 is needed.

It will be obvious to one skilled in the art
that surfactants are useful for proper wetting of the
substrate to be plated. They are also helpful in
25 preventing gas bubbles from adhering to the surface of
the substrate. However, the presence of a surfactant in
the plating bath is not an essential part of this
invention. If the use of a surfactant is desired, the
surfactant provided in the plating bath may be Fluorad
30 FC-95 or Fluorad FC-98, both being anionic surfactant
products of the 3M Company. Other surfactants such as,
but not limited to, sodium lauryl sulfate can also be

used. The surfactant constituent, if present, is used in a concentration of about 0.01-0.03 g/l for the Fluorad type surfactants and about 0.2-0.5 g/l for sodium lauryl sulfate.

5

The electroplating in this invention is performed at a temperature range between 10°C and 46°C. The best film properties of CoFe are achieved between 10° and 25°C.

10

The following examples are given to illustrate the scope and spirit of the present invention. Because these examples are given for illustrative purposes only, the present invention should not be interpreted as being limited thereto.

15

EXAMPLES

A series of examples were prepared wherein the CoFe alloy films were electroplated from a plating bath. The plating bath was an aqueous solution, having a pH of 3, of the following constituents whose concentrations are provided below, except for the cobalt and sulfate salt constituents whose concentrations varied to provide a range of concentration of the resultant CoFe alloy films. The examples included CoFe alloy films within and outside the present invention insofar as the iron concentration of the CoFe alloy film ranged between 35 wt% and 70 wt%. In all cases, the plating occurred at a current density of 10 to 20 mA/cm². During plating the temperature was maintained at 21.3°C accompanied by a paddle speed of 1 Hz.

These examples, within and outside the scope of the present invention, produced cobalt-iron alloy films. The films including their physical properties are summarized in the Table and are pictorially depicted in Figures 1-6.

5

For illustrative purposes four examples of plating solutions, including the resultant alloy films, are set forth below. Since these examples are provided for illustrative purposes only, the invention should not be deemed limited thereto.

10

EXAMPLE 1

Constituent	Concentration, g/l
Acetic acid	3
Boric acid	25
CoSO ₄ .7H ₂ O	17.54
FeSO ₄ .7H ₂ O	62.95
Sodium benzene sulfinate	0.09
FC-95 surfactant	0.01

10

15

This particular bath composition, having a molar ratio of Fe/(Fe+Co) of 0.784 yields of a film containing 72.37 wt% Fe and 27.63 wt% Co. This film, denoted in the Table as Alloy Film No. 26, is within the scope of the present invention.

EXAMPLE 2

Constituent	Concentration, g/l
Acetic acid	12
Boric acid	25
CoSO ₄ .7H ₂ O	53
FeSO ₄ .7H ₂ O	122
Sodium benzene sulfinate	0.09
FC-95 surfactant	0.01
NaCl	0.5

This particular bath composition, having a molar ratio of Fe/(Fe+Co) of 0.699, yields a film denoted in the Table as Alloy Film No. 16, within the scope of the present invention.

EXAMPLE 3

Constituent	Concentration, g/l
Acetic acid	12
Boric acid	25
CoSO ₄ .7H ₂ O	53
FeSO ₄ .7H ₂ O	102
Sodium benzene sulfinate	0.04
FC-95 surfactant	0.01
NaCl	0.5

The film produced by the above plating bath composition is set forth in the Table as Alloy Film No.

10. The film of this example was within the scope of the present invention.

EXAMPLE 4

Constituent	Concentration, g/l
Acetic acid	12
Boric acid	25
CoSO ₄ .7H ₂ O	53
FeSO ₄ .7H ₂ O	42
Sodium benzene sulfinate	0.02
FC-95 surfactant	0.01
NaCl	0.5

The product of this plating bath composition produced Alloy Film No. 1, outside the scope of the present invention.

15

TABLE

	Alloy Film No.	Fe wt.%	Co wt.%	Hc (easy) (Oe)	Stress (Mpa)	4πMs (Tesla)	Specific Resistance μΩ-cm	Hk (hard) (Oe)	Hc (hard) (Oe)
5	1	35.22	64.78	50.32	139.3	2.14	8.76	124.5	48.78
	2	40	60	46.02	223.3	2.26	8.89	118.9	47.69
	3	41.7	58.3	46.05	136.1	2.3	9.71	111.2	45.53
	4	44.37	55.63	40.38	198.9	2.32	10.31	103	42.11
	5	45.88	54.12	31.8	289.7	2.36	11.27	91.9	37.39
10	6	49.39	50.61	26.96	383	2.46	12.55	73.97	28.02
	7	50.47	49.53	25.17	211.1	2.4	14.37	45.88	24.2
	8	52.74	47.26	21.29	299	2.39	15.87	33.41	16.92
	9	54.98	45.02	21.29	380	2.39	17.35		
	10	57.22	42.78	19.2	484.8	2.33	19.29	26.49	10.78
15	11	58.34	41.66	17.38	247.7	2.45	19.3	26.98	8.049
	12	59.34	40.66	16.29	470.9	2.46	24.17		5
	13	60.87	39.13	17.37		2.49	21.37	20.21	6.863
	14	61.58	38.42	14.94		2.47	23.28	21.13	5.609
	15	61.69	38.31	14.66		2.43			5
20	16	62.13	37.87	13.28	599	2.41	31.48	18.17	5.009
	17	62.68	37.32	12.66	569.9	2.5	35.82	19.22	4.857
	18	62.96	37.04	13.87		2.53			5
	19	63.11	36.89	13.84		2.32			5
	20	65.52	34.48	8.855	527.4	2.38	40.33	15.19	3.314
25	21	65.52	34.48	9.463	460.9	2.42	37.34	14.87	3.488
	22	67.29	32.71	8.231	697.9	2.47	43.14	13.19	3.169
	23	69.09	30.91	6.536		2.47	48.45	13.51	3.618
	24	69.96	30.04	7.247		2.37		18.59	2.208
	25	72.2	27.8	6.878		2.331		14.34	1.809
30	26	72.37	27.63	6.491		2.34		15.7	1.98
	27	74.3	25.7	6.863		2.333		13.32	1.66

The above embodiments and examples are given to illustrate the scope and spirit of the present invention. These embodiments and examples will make apparent, to those skilled in the art, other embodiments and examples. These other embodiments and examples are within the contemplation of the present invention. Therefore, the present invention should be limited only by the appended claims.

WHAT IS CLAIMED IS:

1 1. A cobalt-iron alloy film comprising an
2 cobalt-iron alloy film having a saturation magnetization
3 of at least about 2.30 Tesla, said film including between
4 about 55% and about 75% iron and the remainder cobalt,
5 said percentage being by weight based on the total weight
6 of the alloy.

1 2. An alloy film in accordance with Claim 1
2 wherein said iron constituent is present in an amount of
3 between about 60% and about 66%.

1 3. An alloy film in accordance with Claim 2
2 wherein said iron constituent is present in an amount of
3 between about 62% and about 65%.

1 4. An alloy film in accordance with Claim 1
2 wherein said saturation magnetization is in the range of
3 between about 2.32 and about 2.50 Telsa.

1 5. An alloy film in accordance with Claim 4
2 wherein said saturation magnetization moment is in the
3 range of between about 2.38 and about 2.53 Telsa.

1 6. An alloy film in accordance with Claim 1
2 wherein said anisotropy is manifested by an easy axis
3 coercivity of no more than about 22 Oe and which drops to
4 no more than about 12 Oe upon annealing; a hard axis
5 coercivity of no more than about 17 Oe which drops to no
6 more than about 9 Oe upon annealing; and a magnetic

7 anisotropy of no more than 30 which is unchanged upon
8 annealing.

1 7. An alloy film in accordance with Claim 6
2 wherein said easy axis coercivity is no more than about
3 17 Oe which drops to no more than about 8 Oe upon
4 annealing; said hard axis coercivity is no more than
5 about 7 Oe which drops to about 3.5 Oe upon annealing;
6 and a magnetic anisotropy of no more than about 24 Oe
7 which is substantially unchanged upon annealing.

1 8. An alloy film in accordance with Claim 7
2 wherein said easy axis coercivity is no more than about
3 15 Oe which drops to no more than about 6 Oe upon
4 annealing; said hard axis coercivity is no more than
5 about 5 Oe which drops to no more than about 2.5 Oe upon
6 annealing; and a magnetic anisotropy of no more than
7 about 20.5 Oe which is substantially unchanged upon
8 annealing.

1 9. An alloy film in accordance with Claim 1
2 wherein said film has a specific resistivity in the range
3 of about 17 and about 65 $\mu\Omega\text{-cm}$.

1 10. An alloy film in accordance with Claim 1
2 wherein said film has an internal mechanical stress
3 resistance in range of between about 250 MPa and about
4 800 MPa.

1 11. A process of making a cobalt-iron alloy
2 film which comprises electrodepositing an alloy film from
3 an aqueous medium which includes one or more ferrous

4 salts, one or more cobaltous salts, an acid which is at
5 least one mono- or polycarboxylic acid having pKa in the
6 range of between about 3.5 and about 5.5, a buffer which
7 is at least one buffer having a pKa of about 6 to 8 which
8 does not co-deposit into said alloy film and an aromatic
9 sulfinic acid or a salt thereof.

1 12. A process in accordance with Claim 11
2 wherein said ferrous salt is a ferrous sulfate salt and
3 said cobalt salt is a cobalt sulfate salt.

1 13. A process in accordance with Claim 12
2 wherein said ferrous sulfate and said cobalt sulfate
3 salts are hydrates.

1 14. A process in accordance with Claim 11
2 wherein said acid is acetic acid, succinic acid, glutaric
3 acid, methylsuccinic acid, mannitol or sorbitol.

1 15. A process in accordance with Claim 14
2 wherein said acid is acetic acid.

1 16. A process in accordance with Claim 11
2 wherein said buffer is boric acid or an alkyl-substituted
3 pyridine.

1 17. A process in accordance with Claim 16
2 wherein said buffer is boric acid, 2-picoline or 2,6-
3 lutidine.

1 18. A process in accordance with Claim 11
2 wherein said aromatic sulfinic acid or salt thereof is a
3 benzenesulfinate salt.

1 19. A process in accordance with Claim 18
2 wherein said benzenesulfinic salt is a sodium salt of a
3 benzenesulfinate hydrate salt.

1 20. A process in accordance with Claim 11
2 wherein said aqueous medium includes a surfactant.

1 21. A process in accordance with Claim 11
2 wherein said aqueous medium includes a halide salt.

1 22. A process in accordance with Claim 20
2 wherein said halide salt is sodium chloride.

1 23. A process in accordance with Claim 11
2 wherein said alloy film is electrodeposited upon an
3 electrically conductive substrate from a wet chemical
4 medium.

1 24. A process in accordance with Claim 23
2 wherein said electrically conductive substrate is a thin
3 film of a nickel-iron alloy, a nickel-cobalt alloy, an
4 iron-cobalt alloy, a cobalt-nickel-iron alloy, an iron-
5 nitrogen alloy, an iron aluminum-boron alloy, rhodium,
6 ruthenium, platinum, gold, copper or palladium.

1 25. A process in accordance with Claim 23
2 where said wet chemical medium includes acetic acid,
3 boric acid, a cobalt sulfate salt, an iron sulfate salt

4 and an alkali metal benzenesulfinate wherein said cobalt
5 salt and iron salt are present such that the weight ratio
6 of iron to cobalt, based on the total iron and cobalt
7 weight in said chemical medium, is at least about 50%.

1 26. A process in accordance with Claim 11
2 wherein said electroplating occurs at an average cathodic
3 current density in the range of between about 5 and about
4 30 milliamperes per square centimeter and wherein said
5 aqueous medium has a pH in the range of about 2.5 to
6 about 3.5.

1 27. A process in accordance with Claim 26
2 wherein said electroplating occurs using direct current,
3 pulsed current, cathodically biased sinusoidal current or
4 pulsed reversed current.

SEARCHED AND SERIALIZED

ABSTRACT OF THE DISCLOSURE

A cobalt-iron alloy film having saturation magnetization of at least about 2.30 Telsa. The film
5 alloy includes about 55 wt% to about 75 wt.% iron and the remainder cobalt. The film is made by a process in which the film is electrodeposited from an aqueous medium which includes one or more ferrous salts, one or more cobaltous salts, a buffer having a pKa of about 6 to about 8, at least one carboxylic acid having a pKa of between about 10 3.5 and about 5.5, an aromatic sulfinic acid or its salt and optionally, a halide salt and/or a surfactant. The alloy film is useful as a write head in magnetic recording.

PROCESSED BY USI

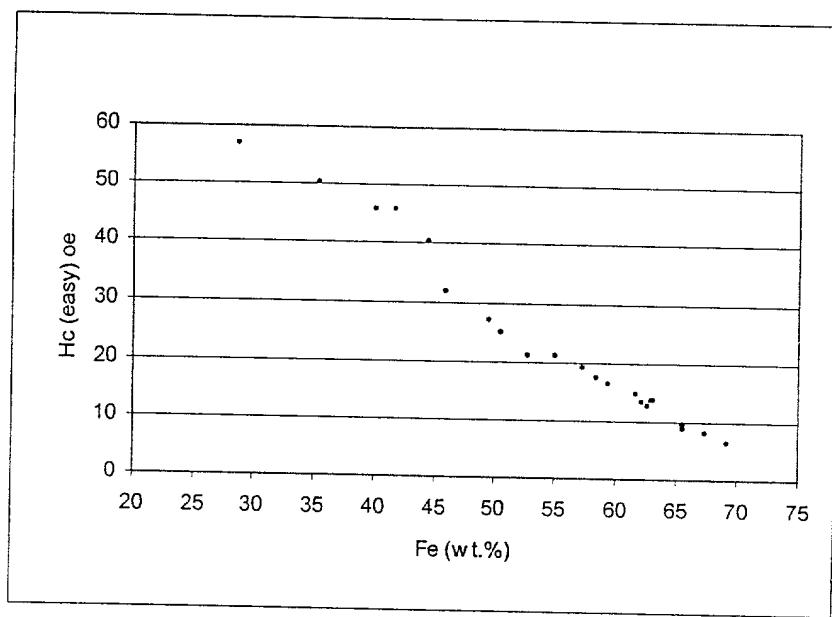


FIGURE 1

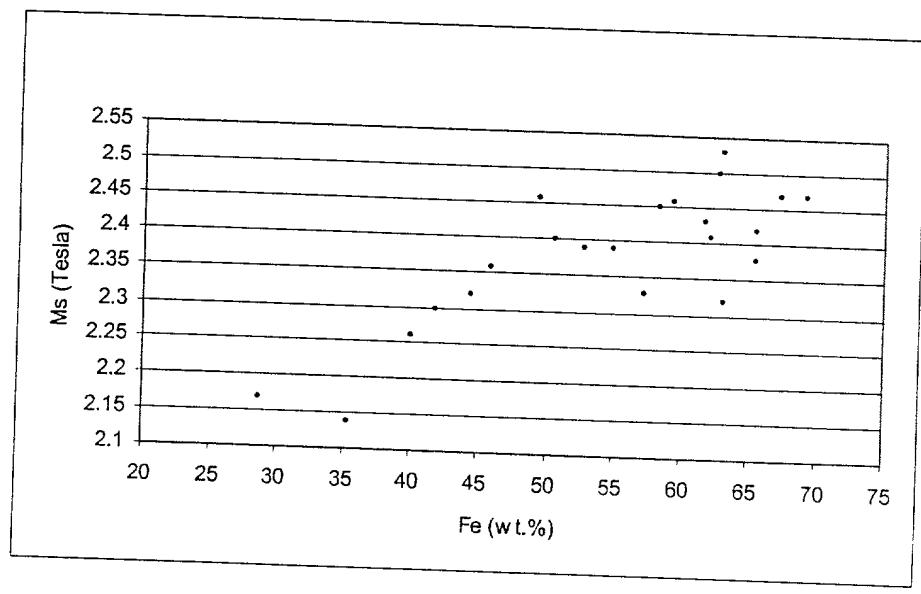


FIGURE 2

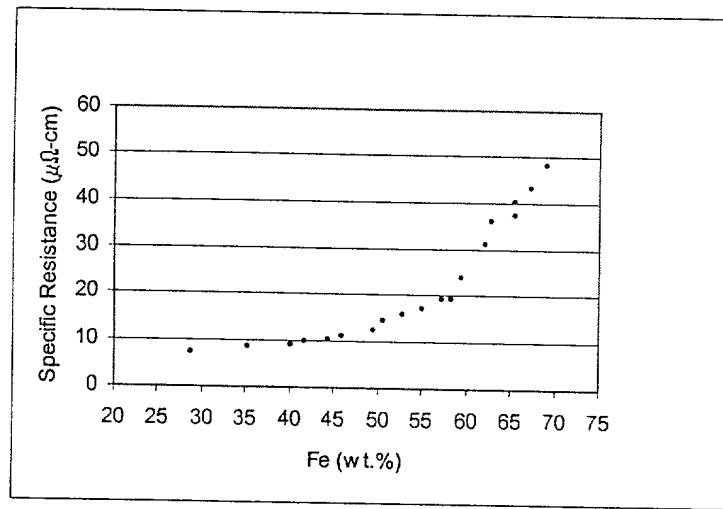


FIGURE 3

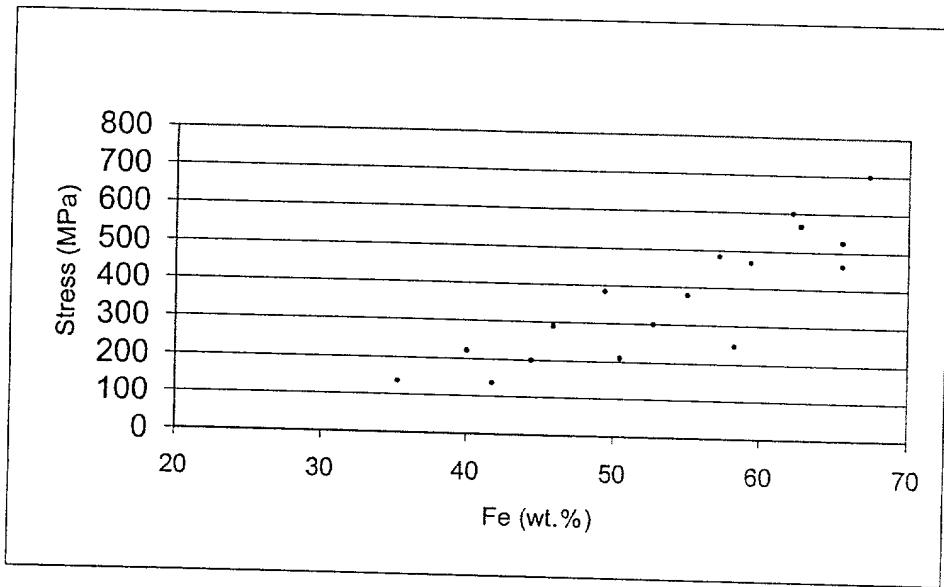


FIGURE 4

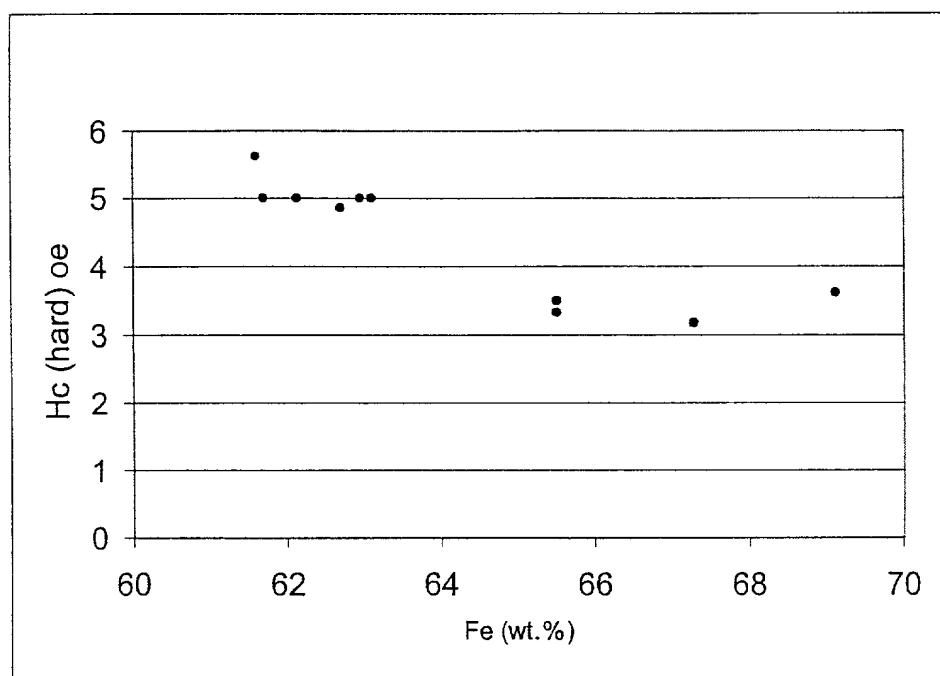


FIGURE 5

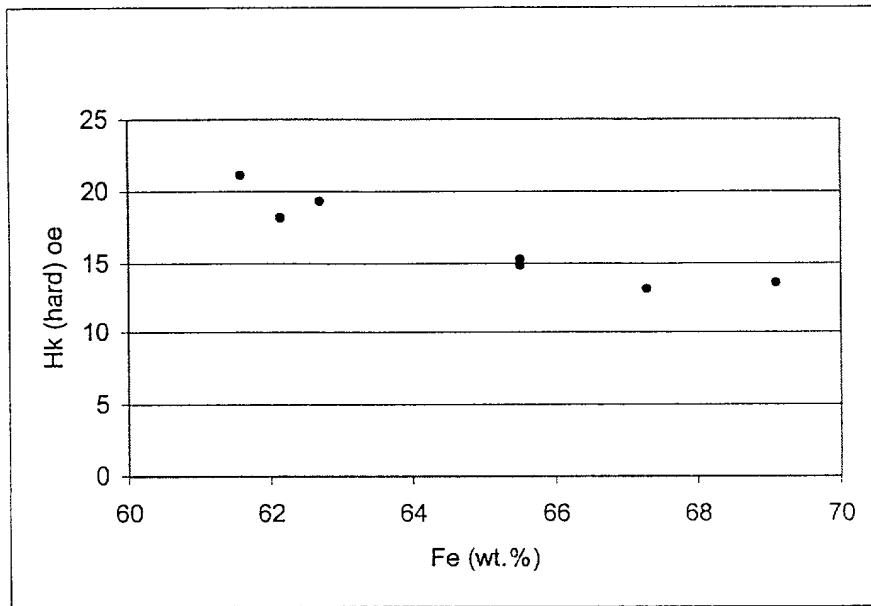


FIGURE 6